



## Product Change Notification - KSRA-20UFUA549

**Date:**

14 Jan 2019

**Product Category:**

8-bit Microcontrollers; Capacitive Touch Sensors

**Affected CPNs:**



**Notification subject:**

CCB 3368.001 Final Notice: Qualification of MMT as an additional assembly site for selected Atmel products of 35.4K, 35.5K and 19.6K available in 32L VQFN (5x5x0.9mm) package

**Notification text:**

**PCN Status:**

Final notification

**PCN Type:**

Manufacturing Change

**Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of MMT as an additional assembly site for selected Atmel products available in 32L VQFN (5x5x0.9mm) package

**Pre Change:**

Assembled at ANAC assembly site with punched as singulation method using 8290 die attach material

**Post Change:**

Assembled at ANAC assembly site with punched as singulation method using 8290 die attach material and Assembled at MMT assembly site with sawn as singulation method using 3280 die attach material

**Pre and Post Change Summary:**

	Pre Change		Post Change	
<b>Assembly Site</b>	Amkor Assembly & Test (Shanghai) Co., LTD / ANAC		Amkor Assembly & Test (Shanghai) Co., LTD / ANAC	Microchip Technology Thailand (Branch) / MMT
<b>Wire material</b>	Au		Au	Au
<b>Die attach material</b>	8290		8290	3280
<b>Molding compound material</b>	G700		G700	G700
<b>Lead frame material</b>	C194		C194	C194
<b>Singulation Method</b>	punched		punched	sawn

All inits in millimeter (mm)		Amkor Assembly & Test (Shanghai) Co., LTD / ANAC			Microchip Technology Thailand (Branch) / MMT		
Dimension Limits		Min	Nom	Max	Min	Nom	Max
<b>Number of terminals</b>	<b>N</b>	32			32		
	<b>e</b>	0.50 BSC			0.50 BSC		

Pitch							
Overall Height	A	0.8	0.85	0.9	0.8	0.9	1.0
Standoff	A1	0	0.01	0.05	0	0.02	0.05
Molded package thickness	A2	0.6	0.65	0.7	N/A		
Terminal Thickness	A3	0.20 REF			0.203 REF		
Overall Length	D	5.00BSC			0.500 BSC		
Molded package length	D1	4.75BSC			N/A		
Overall Width	E	5.00BSC			5.00 BSC		
Molded package Width	E1	4.75BSC			N/A		
Exposed Pad Length	D2	3.0	3.1	3.2	3.0	3.1	3.2
Exposed Pad Width	E2	3.0	3.1	3.2	3.0	3.1	3.2
Terminal Length	L	0.3	0.4	0.5	0.3	0.4	0.5
Terminal-to-exposed-pad	K	0.2	-	-	0.2	-	-
Mold angle		0		12 <sup>0</sup>	N/A	N/A	N/A
Package Chamfer	P	0.24	0.42	0.6	N/A	N/A	N/A
Exposed Tie Bar Length	Q	0.3	0.4	0.65	N/A	N/A	N/A
Exposed Tie Bar Width	R	0.13	0.17	0.23	N/A	N/A	N/A
POD Drawing		see attachment (PCN_KSRA-20UFUA549_Pre-Change_POD Drawing_ANAC_Punched)			see attachment (PCN_KSRA-20UFUA549_Pre-Change_POD Drawing_MCHP_Sawn)		

The dimensions of the products from MMT are within the specifications of the package from ANAC.

**Impacts to Data Sheet:**

Yes; Package outline drawing- change from punch version to saw singulated

**Change Impact:**

None

**Reason for Change:**

To improve productivity by qualifying MMT as an additional assembly site

**Change Implementation Status:**

In Progress



**Estimated First Ship Date:**

February 14, 2019 (date code: 1907)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

**Time Table Summary:**

	January 2019					February 2019			
Workweek	01	02	03	04	05	06	07	08	09
Qual Report Availability		X							
Final PCN Issue Date		X							
Estimated Implementation Date							X		

**Method to Identify Change:**

Traceability code

**Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

**Revision History:**

**January 14, 2019:** Issued final notification. Attached the Qualification Report. Provided estimated first ship date on February 14, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

[PCN\\_KSRA-20UFUA549\\_Qual\\_Report.pdf](#)

[PCN\\_KSRA-20UFUA549\\_Pre-Change\\_POD\\_Drawing\\_ANAC\\_Punched.pdf](#)

[PCN\\_KSRA-20UFUA549\\_Post-Change\\_POD\\_Drawing\\_MCHP\\_Sawn.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

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If you wish to change your PCN profile, including opt out, please go to the [PCN home page](#) select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

Affected Catalog Part Numbers (CPN)

AT42QT1244-MUR  
AT42QT1245-MU  
AT42QT1245-MUR  
ATMEGA168-20MQ  
ATMEGA168-20MQR  
ATMEGA168-20MUR  
ATMEGA168P-20MUR  
ATMEGA168PA-MN  
ATMEGA168PA-MNR  
ATMEGA168PA-MUA1  
ATMEGA168PA-MURA1  
ATMEGA168PV-10MUR  
ATMEGA168V-10MQ  
ATMEGA168V-10MQR  
ATMEGA168V-10MQR610  
ATMEGA48A-MU  
ATMEGA48A-MUR  
ATMEGA48P-20MUR  
ATMEGA48PA-MNR  
ATMEGA48PA-MURA5  
ATMEGA48V-10MUR  
ATMEGA48V-10MURA3  
ATMEGA88-20MUR  
ATMEGA88PA-MN  
ATMEGA88PA-MNR  
ATMEGA88PA-MURA6  
ATMEGA88V-10MURA1  
ATMEGA8L-8MUA4  
ATMEGA8L-8MURA3  
ATMEGA8L-8MURA5  
ATTINY26-16MQR  
ATTINY261A-MF  
ATTINY261A-MFR  
ATTINY28L-4MU  
ATTINY28V-1MU  
ATTINY828-MU  
ATTINY828-MUR  
QT60160-ISG  
QT60240-ISG